ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® Material Composition D © Copyright 2005. IPC, Bannoc international and Pan-American	kburn, Illinois. A	ll rights reserved und tions.	der both This docu level parts	nent is a dec , the declara	claration tion end	n of the substance compasses all low	es within the manufactur ver level materials for w	er listed ite hich the m	em. Note: if tl anufacturer h	he item is an ass as engineering r	sembly with lower esponsibility.
IPC Web Site for Information o. http://www.ipc.org/IPC-175x	IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Distr							als and Mfg Information			
Supplier Information											
Company name* Company unique ID				Unique ID Authority				Response Date*			
nsemi								2025-06-05			
Contact Name	zt Name Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards	duct-Env-Stewards Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
thorized Representative* Title - Representative				Phone - Representative*				Email - Representative*			
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Ite	m Number	Mfr Item Name		Effective	Date	Version	Manufacturing Site		Veight*	UOM	Unit Type
NCP1:	P1399APDR2G High Perf Current with Integrated H		Mode Resonant Controlle	r 2025-06-	05		TH6	1	32.3281	mg	Each
Manufacturing Proccess Information											
Terminal Plating / Grid Array Material	inal Plating / Grid Array Material Terminal Base Alloy J-		STD-020 MSL Rating	Peak Process Body Temperature Max Ti		ure Max Time at Peak	k Temperature Number of Reflow Cycles		es		
Matte Tin (Sn) - annealed CU Alloy 3			260		С	30	second	is 3			
Comments											
ATTENTION: MSL 3 Rated item requires Bake and	Dry Pack (after	electrical test)									
For more information regarding material composition	n please refer to	page 3									

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material Weight		Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.6562	mg	Supplier	Silicon (Si)	7440-21-3		0.6562	mg
Die Attach	0.875	mg		Epoxy resin	proprietary data		0.0437	mg
			Supplier	4-Methylhexahydrophthalsureanhydrid	19438-60-9		0.0044	mg
			Supplier	Titanium triisostearoylisopropoxide	61417-49-0		0.0437	mg
			Supplier	2,2-dimethyl-1,3-propanediyl dimethacrylate	1985-51-9		0.0437	mg
			Supplier	2-(3,4- Epoxycyclohexyl)ethyltrimethoxysilane	3388-04-3		0.0437	mg
			Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.0044	mg
			Supplier	1,4-Bis(2,3-epoxypropoxy)butane	2425-79-8		0.0437	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.0437	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.6037	mg
Lead Frame	43.7501	mg	Supplier	Silver (Ag)	7440-22-4		0.105	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0831	mg
			Supplier	Iron (Fe)	7439-89-6		1.1331	mg
			Supplier	Copper (Cu)	7440-50-8		42.3676	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0613	mg
Mold Compound-Black	84.2031	mg		Epoxy resin	proprietary data		8.8834	mg
			Supplier	Phenolic Resin	Proprietary Data		2.5261	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		2.5261	mg
			Supplier	Carbon Black (C)	1333-86-4		0.421	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		69.8465	mg
Plating	2.2031	mg	Supplier	Tin (Sn)	7440-31-5		2.2031	mg
Wire Bond	0.6406	mg	Supplier	Palladium (Pd)	7440-05-3		0.0128	mg
			Supplier	Gold (Au)	7440-57-5		0.0032	mg
			Supplier	Copper (Cu)	7440-50-8		0.6246	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).